

ABSTRACT

FILM-LAMINATED METAL SHEET AND METHOD FOR PRODUCING THE SAME,
SUBSTRATE FOR FLEXIBLE ELECTRONICS, AND ORGANIC EL SUBSTRATE

Provided are a film-laminated metal sheet which satisfies smoothness, heat resistance, flexibility, and gas barrier properties and has a low environmental burden and excellent productivity and a method for producing the metal sheet, a substrate for flexible electronics, and an organic EL substrate.

The film-laminated metal sheet has at least one surface covered with a resin film. The arithmetic average roughness S_a of a surface of the resin film is 0.030 μm or less. The maximum peak height S_p of the surface of the resin film is 0.30 μm or less. The maximum valley depth S_v of the surface of the resin film is 1.0 μm or less.